## 90W, 28V High Power RF LDMOS FETs

#### **Description**

The MJ1509 is a 90-watt, highly rugged, unmatched LDMOS FET, designed for wide-band commercial and industrial applications at frequencies HF to 1.5 GHz. It can be used in Class AB/B and Class C for all typical modulation formats.

•Typical Performance (On Innogration fixture with device soldered):

 $V_{DD}$  = 28 Volts,  $I_{DQ}$  = 500 mA, CW.

Frequency	Gp (dB)	P <sub>-1dB</sub> (W)	η <sub>D</sub> @P <sub>-1</sub> (%)
1000 MHz	18	90	60

•Typical Performance (In Innogration broadband demo): V<sub>DD</sub> = 28 Volts, I<sub>DQ</sub> = 200 mA, CW.

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Freq (MHz)	Gp (dB)	P <sub>-1dB</sub> (W)	η <sub>D</sub> @P <sub>-1</sub> (%)
30	18.2	57.5	49.3
60	18.7	75.9	57.4
100	20.0	79.4	60.2
200	20.7	79.4	64.0
300	20.3	67.6	61.8
400	18.3	57.5	56.3
512	16.9	51.3	55.5

#### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCl drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

#### **Suitable Applications**

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz 1000MHz (ISM, instrumentation)

**Table 1. Maximum Ratings** 

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+95	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+40	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

**Table 2. Thermal Characteristics** 

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Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	0.7	OCAN.
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, DC test	RθJC	0.7	°C/W

#### **Table 3. ESD Protection Characteristics**

Test Methodology	Class	
Human Body Model (per JESD22A114)	Class 2	

#### **Table 4. Electrical Characteristics** ( $T_A = 25$ °C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics (per half section)					
Drain-Source Voltage	V	95			V
V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA	V <sub>(BR)DSS</sub>	95			V
Zero Gate Voltage Drain Leakage Current	I <sub>DSS</sub>			1	μΑ
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$	IDSS				μΑ
GateSource Leakage Current	I <sub>GSS</sub>			1	
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	IGSS			ı	μΑ
Gate Threshold Voltage	V <sub>GS</sub> (th)		2.17		V
$(V_{DS} = 28V, I_{D} = 150 \mu A)$	V GS(U1)		2.17		V
Gate Quiescent Voltage	$V_{GS(Q)}$		3.3		V
(V <sub>DD</sub> = 28 V, I <sub>D</sub> =500 mA, Measured in Functional Test)	V GS(Q)		3.3		V
Common Source Input Capacitance	C <sub>ISS</sub>		54		pF
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	Oiss		54		Pi
Common Source Output Capacitance	Coss		18		pF
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	Coss		10		рі
Common Source Feedback Capacitance	C <sub>RSS</sub>		1.2		pF
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)			1.2		ρi

#### Functional Tests (In Demo Test Fixture, 50 ohm system) $V_{DD}$ = 28 Vdc, $I_{DQ}$ = 500 mA, f = 1000 MHz, CW Signal Measurements.

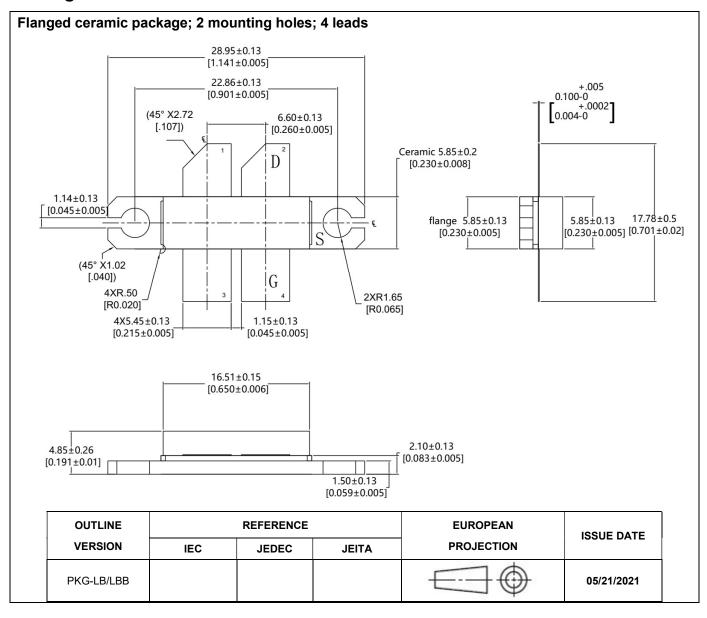
Power Gain	Gp	18	dB
Drain Efficiency@P1dB	η <sub>D</sub>	60	%
1 dB Compression Point	P <sub>-1dB</sub>	90	W
Input Return Loss	IRL	-7	dB

Load Mismatch (In Innogration Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ Vdc}$ ,  $I_{DQ} = 500 \text{ mA}$ , f = 1000 MHz

VSWR 20:1 at 90W pulse CW Output Power	No Device Degradation
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# **MJ1509 LDMOS TRANSISTOR**

### **Package Outline**



Document Number: MJ1509 Preliminary Datasheet V1.1

#### **Revision history**

Table 5. Document revision history

Date	Revision	Datasheet Status
2017/05/20	Rev 1.0	Preliminary Datasheet
2022/9/19	Rev 1.1	LBB outline updated

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